

### TOSHIBA Diode Silicon Epitaxial Planar Type

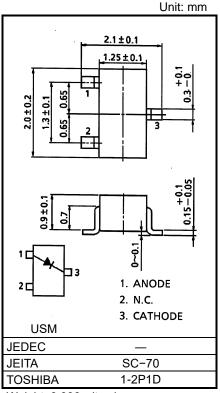
# **1SS370**

# High Voltage, High Speed Switching Applications

• Small package : SC-70

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V <sub>RM</sub>	250	V	
Reverse voltage	V <sub>R</sub>	200	V	
Maximum (peak) forward current	I <sub>FM</sub>	300	mA	
Average forward current	lo	100	mA	
Surge current (10ms)	IFSM	2	Α	
Power dissipation	P <sub>D</sub> (Note 1, 3)	200	mW	
	P <sub>D</sub> (Note 2)	100		
Junction temperature	Tj (Note 1)	150	°C	
	T <sub>j</sub> (Note 2)	125		
Storage temperature	T <sub>stg</sub> (Note 1)	−55 to 150	°C	
	T <sub>stg</sub> (Note 2)	−55 to 125		



Weight: 0.006g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For devices with the ordering part number ending in LF(T.

Note 2: For devices with the ordering part number in other than LF(T.

Note 3: Mounted on a FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.5 mm<sup>2</sup> × 3)

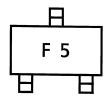
Start of commercial production 1993-09



# **Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	IF = 10 mA	_	0.72	1.0	V
	VF (2)	I <sub>F</sub> = 100 mA	_	0.90	1.2	
Reverse current	IR (1)	V <sub>R</sub> = 50 V	_	_	0.1	μΑ
	I <sub>R (2)</sub>	V <sub>R</sub> = 200 V			1.0	
Total capacitance	Ст	$V_R = 0 V$ , $f = 1 MH_Z$		1.5	3.0	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 mA, Fig.1	_	10	60	ns

# Marking



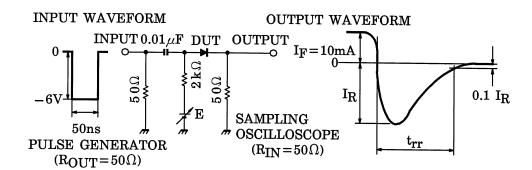
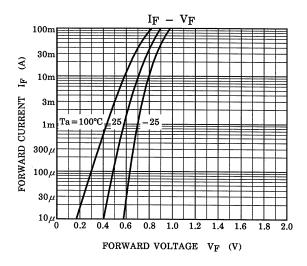
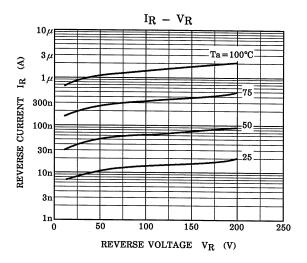


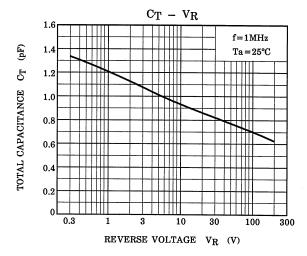
Fig.1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit

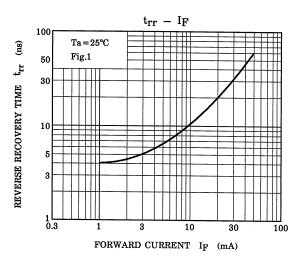


## **Characteristics Curves**









The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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